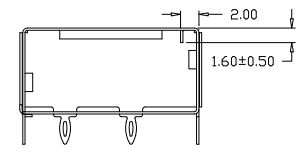
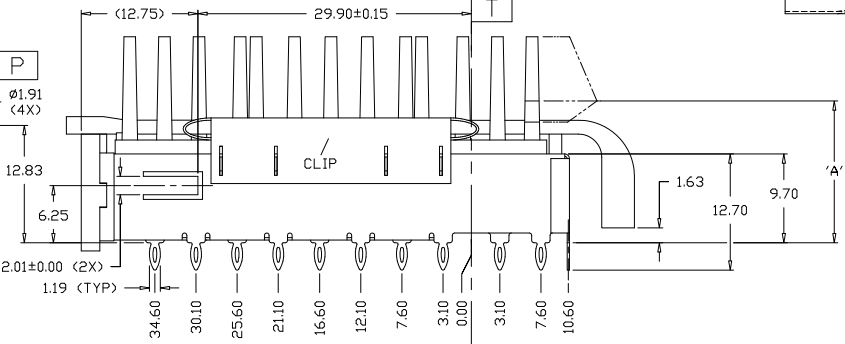
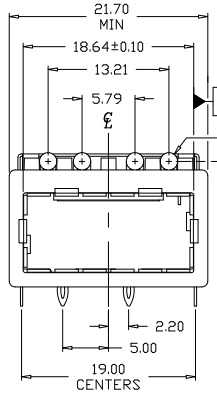
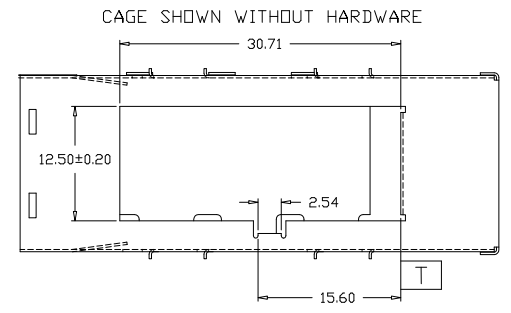
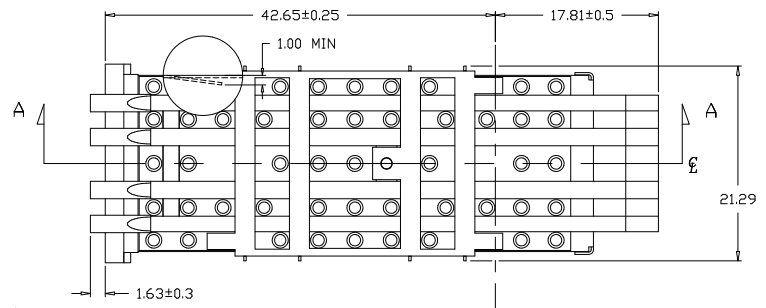
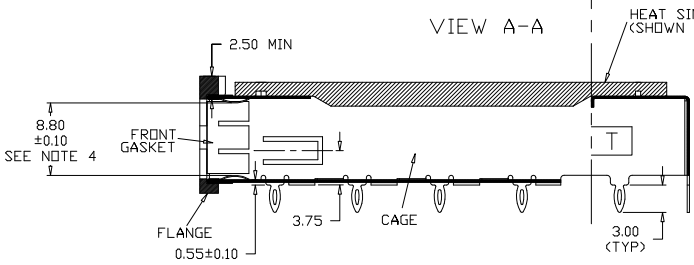


LTR.	ECN	DESCRIPTION	DATE	APP'D.



VIEW A-A



A DIMENSION
WHEN MODULE IS INSERTED
AND HEAT SINK IS RAISED

13.69 mm	PCI
16.00 mm	SAN
23.01 mm	NET

DRAWING SHOWS CAGE WITHOUT MODULE

DM9054-F-H-X-4L

DENOTES 4 LIGHTPIPES
 DENOTES FLANGE STYLE
 SERIES
 DENOTES 4 LIGHTPIPES
 PLATING OPTIONS:
 (ALL ARE ROHS COMPLIANT)
 -R FOR 100µIN MATTE TIN OVER 50µIN NICKEL
 NOT INTENDED FOR REFLOW
 WAVE SOLDER ONLY - WAVE TEMP. 260°C FDR 6 SEC. MAX
 -N FOR 100µIN NICKEL
 NOT INTENDED FOR REFLOW
 WAVE SOLDER ONLY - WAVE TEMP. 260°C FDR 6 SEC. MAX
 HEAT SINK OPTION:
 -P FOR PCI HEIGHT
 -S FOR SAN HEIGHT
 -N FOR NETWORK HEIGHT (NET)

NOTES:

- 1) CAGE MATERIAL: 0.25 mm ± 0.3 mm THICK BRASS C2680, FULL HARD. PLATING: SEE PLATING OPTIONS.
- 2) FRONT GASKET MATERIAL: 0.06 mm THICK BERYLLIUM COPPER, NICKEL PLATED. SPOT WELDED TO CAGE.
- 3) HEAT SINK AND FLANGE MATERIAL: ZAMAC 3. NICKEL PLATED.
- 4) WHEN GASKET IS FULLY COMPRESSED.
- 5) CLIP MATERIAL: 0.25 mm THICK BERYLLIUM COPPER, PLATING: NICKEL.
- 6) LIGHTPIPE MATERIAL: CLEAR POLYCARBONATE
- 7) OPERATING AND STORAGE TEMPERATURE: -40°C TO +125°C
- 8) TEMPERATURE FROM WAVE SOLDER NOT TO EXCEED 125°C AT LIGHTPIPE

DO NOT SCALE DRAWING.



EXPERIMENTAL NO:		DIVISION ASSIGNED: dataMate Division	
UNLESS OTHERWISE SPECIFIED		MATERIAL:	DATE:
TOLERANCE:		SEE NOTES	10/15/12
METRIC		FINISH:	CHECKED BY:
± 0.25 mm DEC	INCHES	SEE NOTES	J. LLORENS
XX ± 0.13 mm DEC	ANGLES ±	ENGR. APPROVAL:	10/15/12
TOOLING DWG □	PART DWG □	B. SKEPNEK	10/15/12
BREAK SHARP EDGES	REMOVE ALL BURRS	APPROVED BY:	10/15/12
THE INFORMATION DISCLOSED IN THIS DOCUMENT IS PROPRIETARY TO METHODE ELECTRONICS. NO PART MAY BE USED FOR MANUFACTURE OR ANY OTHER PURPOSE WITHOUT THE WRITTEN CONSENT OF METHODE. DETAILS SUBJECT TO CHANGE AS THEY MAY VARY WITH RESPECT TO PRODUCT APPROVAL.		PART NO. CLASSIFICATION:	DATE:
SIZE		CODE IDENT.	DWG. NUMBER
C			DM9054-F-H-X-4L
SCALE:			Rev.

